Supplier Name:	Texas Instruments Inc. (DUNS# 00-732-1904)
Contact Info:	ti.com/support
Form/Declaration Type:	Distribute - RoHS and IEC 62474 DB
Created on:	06/12/2022

Details for "TPS78511QWDRBRQ1"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
TPS78511QWDRBRQ1	NIPDAU	Level-2-260C-1 YEAR	TI Semiconductor	DRB 8	3x3x0.9	23.5

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

				Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.03877	97.537045	975370	0.164988	1650
Not Categorized	Proprietary Materials		0.000004	0.010063	101	0.000017	0
Precious Metals	Gold	7440-57-5	0.00002	0.050316	503	0.000085	1
Precious Metals	Palladium	7440-05-3	0.000954	2.40006	24001	0.00406	41
Precious Metals	Silver	7440-22-4	0.000001	0.002516	25	0.000004	0
Sub-Total			0.039749	100	1000000	0.169155	1692
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	0.17365	80.000184	800002	0.73898	7390
Thermoplastics	Ероху	85954-11-6	0.043412	19.999816	199998	0.184743	1847
Sub-Total			0.217062	100	1000000	0.923722	9237
Lead Frame		-	•				
Copper and Its Alloys	Copper	7440-50-8	10.14884	97.585	975850	43.189095	431891
Copper and Its Alloys	Iron	7439-89-6	0.2392	2.3	23000	1.017932	10179
Copper and Its Alloys	Phosphorus	7723-14-0	0.00156	0.015	150	0.006639	66
Zinc and Its Alloys	Zinc	7440-66-6	0.0104	0.1	1000	0.044258	443
Sub-Total			10.4	100	1000000	44.257924	442579
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.242556	95.12	951200	1.032214	10322
Precious Metals	Gold	7440-57-5	0.001989	0.78	7800	0.008464	85
Precious Metals	Palladium	7440-05-3	0.010455	4.1	41000	0.044492	445
Sub-Total			0.255	100	1000000	1.08517	10852
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	10.482484	87.999997	880000	44.60894	446089
Other Organic Materials	Chlorine	7782-50-5	0.000119	0.000999	10	0.000506	5
Other Plastics and Rubber	Carbon Black	1333-86-4	0.035736	0.300002	3000	0.152077	1521
Thermoplastics	Ероху	85954-11-6	1.393575	11.699002	116990	5.930455	59305
Sub-Total			11.911914	100	1000000	50.691979	506920
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	0.674892	100	1000000	2.87205	28720
Sub-Total			0.674892	100	1000000	2.87205	28720
Total			23.498617			100	1000000

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component.

See Glossary of Terms for more details.

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/12/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.